# **Product Specification** 108-60027 AMP Mini CT Hybrid Drawer Connector, 1.5mm Pitch **Lead Free Version**

1. Scope:

1.1 Contents:

> This specification covers the requirements for product performance, test methods and quality assurance provisions of AMP Mini CT Hybrid Drawer Connector, 1.5mm Pitch, Lead Free Version. Applicable product description and part numbers are as shown in Fig.1.

Product Part No.	Description
x-292239-x	Plug Assembly, 1.5mm Pitch Mini CT Hybrid Drawer Connector, Lead Free
x-292240-x	Receptacle Assembly, 1.5mm Pitch Mini CT Hybrid Drawer Connector Lead Free
x-292241-x	Plug Assemble, 1.5mm Pitch Mini CT SF Hybrid Drawer Connector, Lead Free
x-292242-x	Receptacle Assembly, 1.5mm Pitch Mini CT SF Hybrid Drawer Connector, Lead Free
x-179316-x	Receptacle Crimp Contact (#16-20) for Drawer Connector
x-179317-x	Receptacle Crimp Contact (#20-24) for Drawer Connector
x-316458-x	Receptacle GND Contact (#16-20) for Drawer Connector
x-179321-x	Plug Crimp Contact (#16-20) for Drawer Connector
x-179322-x	Plug Crimp Contact (#20-24) for Drawer Connector

Fig. 1

#### 2. Applicable Documents

The following documents form a part of this specification to the extent specified herein. In the event of conflict between the requirements this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements this specification and referenced documents, this specification shall take precedence.

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RMATION IS CONFIL TION THAT NO FUR THAN AMP PERSO AMP SHANGHAI L					снк S. Y	ANG YAO ASAKI	Electronics	Tyco Elec AMP Shan	ghai Lt				
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2.1 AMP	Specifications:
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		Material:		Glass-filled F	BT UL94V-0			
		Finish (Tin Ve C. Housing		Pre-plated Ti			terplating	5
		Material: Finish (Gold V		Brass Gold (mating	area) Tin (crit	np area) over Nickel und	derolating	T
	1	B. Power Contact		ii) Gold over	Palladium-Nic	kel over Nickel underpla	ating	
		Finish (Mini C Finish (Drawer	- /		ver Nickel unde ng over Nickel	underplating, or		
		Material:		Phosphor Bro				
		A. Signal Contact						
3	3.2.1	Plug Assembly						
3	3.2	Materials:						
		Product shall be of product drawing.	the design, constru	ction and phy	rsical dimension	ns specified on the appli	cable	
3	3.1	Design and Constru	action:					
3	<b>3</b> . ]	Requirements:						
	-	B. IEC: Internation	nal Electrotechnical	Comission				
		A. MIL-STD-202:	Test Methods for	Electronic an	d Electrical Co	mponent Parts.		
2	2.2	Commercial Stand	ards and Specificat	ions:				
		C. 501-51021	Qualification Tes	st Report				
	1	B. 114-5182	Application Spec	ification				
		A. 109-5000	Test Specification	n, General Re	equirements for	Test Methods		

#### 3.2.2 Receptacle Assembly

A. Signal Contact

	Material:	Brass
	Finish (Mini CT post area):	Tin plating over Nickel underplating
	Finish (Drawer mating area):	i) Gold plating over Nickel underplating
		ii) Gold over Palladium-Nickel over Nickel underplating
B.	Power Contact	
	Material:	Phosphor Bronze
	Finish (Gold Version):	Gold (mating area), Tin (crimp area) over Nickel underplating
	Finish (Tin Version):	Pre-plated Tin
C.	Housing	
	Material:	Glass-filled PBT UL94V-0

3.3 Ratings:

A.	Voltage Rating (Signal):	50 V(AC/DC)
	Voltage Rating (Power):	250 VAC
B.	Current Rating (Signal):	1A Max
	Current Rating (Power):	AWG #16 (1.25 mm <sup>2</sup> ): 12 A
		AWG #18 (0.85 mm <sup>2</sup> ): 10 A
		AWG #20 (0.5 mm <sup>2</sup> ): 7 A
		AWG #22 (0.3 mm <sup>2</sup> ): 5 A
		AWG #24 (0.2 mm <sup>2</sup> ): 4 A
C.	Temperature Rating:	-30°C to +105°C

The upper limit of the temperature includes the temperature rising resulted by the energized electrical current.

#### 3.4 Performance Requirements and Test Descriptions:

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Fig.2. All tests shall be performed in the room temperature unless otherwise specified.

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Para.	Test I	tems		Requi	rements			Procedures					
3.5.1	Examination	of product	requirer	shall be onents of a shall be onents of a shall be one of a shall	applicabl			Visually, dimensionally and functionally inspected per applicable quality inspection plan					
				Electr	rical Req	luireme	nts						
3.5.2	Termination (Low Level)		40 mΩ Power I 6 mΩ N	Max. (In Max. (Fi	nal) al)			Subject mated connectors to 20 mV Max open circuit at 10 mA Refer Fig. 4					
3.5.3	Dielectric wi voltage		No cree shall oc Current Signal I Power I	ping disc cur. leakage: Line 5mA Line 1mA	harge or Max. Max.	flashov	rer	Signal Line: 500 VAC for 1 minute. Power Line: 1.8 kVAC for 1 minute. Test between adjacent circuits of mated connectors. MIL STD 202 TEST Method 301 IEC 512-2 TEST 4A					
3.5.4	Insulation Re	esistance		2 Min. (In 2 Min. (Fi				Impressed voltage 500VDC for 1 minute. Test between adjacent circuits of mated connectors. MIL STD 202 TEST Method 302 Condition B					
3.5.5	Temperature Current	Rising vs.	30°C M current	ax. under	loaded	rating		Contacts series-wired, apply test current of loaded rating current to the circuit, and measure the temperature rising by probing on soldered areas of contacts, after the temperature becomes stabilized deduct ambient temperature from the measured value					
				Mecha	nical Re	quirem	ents	vulue		_			
3.5.6	Crimp Tensil (Power conta		wire Size         (Min.) $mm^2$ AWG         N         kg           0.2         #24         19.6         2.           0.3         #22         34.3         3.           0.5         #20         45.1         4.           0.85         #18         98.0         10					Apply an axial pull-off load to a crimp wire, with the contact secured to the tester. Operation Speed: 100 mm/min.					
3.5.7								Measure force required to insert of into housing.	contact				
				Fig	.2. To b	e contin	nued						
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### 3.5 Test Requirements and Procedures Summary:

Para.	Test items	Require	ements	5	Procedures						
3.5.8	Contact Retention Force	Signal Contact: Receptacle: 14.7N Tab: 7.84 N(0.8kg Power Contact: 58.9 N (6.0 kgf) N	gf) Mi		Measure contact retention force. Operation Speed: 100 mm/min.						
3.5.9	Connector Mating Force	Pos. size (Power Initial /Signal) 40.2N 4/12 (4.1 kgf)		After Durability 60.8N (6.2 kgf)	Operation Speed: 100 mm/min. Measure the force required to mated connectors						
3.5.10	Connector Unmating Force	Pos. size (Power/Signal) 4/12	ax. Initia Dura	Max. al & After ability Min. 6.5 N 0.66 kgf)	Operation Speed: 100 mm/min. Measure the force required to unmate connectors.						
3.5.11	Panel Retention Force (For Snap-Fit only)	98N (10 kgf) Min.			Measure panel retention force using pa of nominal cut-out dimension as specif in the AMP Customer Drawing. Loadi made from the direction opposite to connector insertion direction.	ied					
3.5.12	Durability (Repeated Mate/Unmating)	Signal Line: 40 m Power Line: 10 m			Operation Speed: 100mm/min. No. of Cycles: Gold Version: 3000 cycles Pre-tin Version: 30 cycles						
3.5.13	Vibration (Low Frequency)	No electrical disco than 1 $\mu$ sec. Shal Signal Line 40 m $\Omega$ Max. (Fina Power Line: 10 m $\Omega$ Max. (Fina	l occu l)		Subject mated connectors to 10-55-101 traversed in 1 minute at 1.52mm amplit 2 hours each of 3 mutually perpendicul planes. MIL-STD-202 TEST Method 201 Condition A Mounting: Fig. 5	ude					
		Fig. 2 (	To be	continued)							
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Para.	Test Items	Requirements		Procedures							
3.5.14	Physical Shock	<ul> <li>No electrical discontinuity greater than 1 μ sec. Shall occur. Signal Line:</li> <li>40 mΩ Max. (Final) Power Line:</li> <li>10 mΩ Max. (Final)</li> </ul>	Accelerated Velocity: 490 mm/s <sup>2</sup> (50G) Waveform: halfsine shock pulse Duration: 11 m sec Number of shocks: 3 shocks in each direction applied along the X, Y and Z axes, totally 18 shocks. MIL-STD-202 TEST Method 213 Condition A IEC 68-2-27, Test Ea Mounting: Fig. 5								
3.5.15	Hammering Shocks	nated connectors to 10,000 cyc ng shocks in set up as shown ir nt of 1 mA at DC 10V applied Fig. 7 e test, the circuit shall be mont n of electrical resistance.	Fig. 6, with to circuits a								
		Environmental R	equirements								
3.5.16	Thermal Shock	Signal Line: 40 mΩ Max. (Final) Power Line: 10 mΩ Max. (Final)	°C/30min cycles.	nated connectors to -55 °C/30n . This being 1 cycle repeat for 0-202 TEST 07		5					
3.5.17	Humidity- Temperature Cycling	Insulation resistance Subject mated connector to 25-65°C, 90-95 %R.									
3.5.18	Salt Spray	Signal Line: 40 mΩ Max. (Final) Power Line: 10 mΩ Max. (Final)	Subject mated connectors to $5\pm1\%$ salt concentration for 48 hours. After test, rinse the samples with water and recondition the room temperature for 1 hour before subsequent measurements MIL-STD-202 TEST Method 101, Condition B. IEC 68-2-11, Test Ka.								
3.5.19	Temperature Life (Heat Aging)	Signal Line: 40 mΩ Max. (Final) Power Line: 10 mΩ Max. (Final)	Subject n	nated connector to 85±2°C, 500 D-202 TEST	) hours.						
		Fig. 2 (	End)			_					
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## 4. Product Qualification Test Sequence

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									Test G	iroup						
Test of Examin	ation	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
								Те	st Sequ	ience(	(a)		-			
Examination of Pr	oduct	1,4,8	1,3	1,3	1,3	1,3	1,3	1,3	1,3	1,5	1,5	1,5	1,5	1,5	1,5	1,5
Termination Resis (Low Level)	tance	2, 5								2,4	2,4	2,4	2,4	2,4	2,4	2,4
Dielectric withstar voltage	nding	7														
Insulation Resistan	nce	6														
Temperature Risin Current	ng vs.		2													
Crimp Tensile Stre	ength			2												
Contact-housing Insertion Force					2											
Contact Retention	Force					2										
Connector Mating	Force						2									
Connector Unmati Force	ing							2								
Panel Retention Fo	orce								2							
Durability Cycling	g									3						
Vibration (Low Frequency)											3					
Physical Shock												3				
Hammering Shock	ĸs												3			
Thermal Shock														3		
Humidity-Temper Cycling	ature	3														
Salt Spray	(114														3	
Temperature Life Aging)	(Heat															3
(a) Numbers indicated sequence in which tests are performed. Fig.3																
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